

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

03.04.2026

WÜRTH  
ELEKTRONIK  
MORE THAN  
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	291		2		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		3		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		4		
		70	L2			
C-RaS-FR4-ML-0.508mm-070+070-TG150-HF...	50203130	510		5	A01	
		70	L3			
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	306		6		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		7		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		8		
		70	L4			
C-RaS-FR4-ML-0.508mm-070+070-TG150-HF...	50203130	510		9	A02	B00
		70	L5			
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	306		10		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		11		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		12		
		70	L6			
C-RaS-FR4-ML-0.508mm-070+070-TG150-HF...	50203130	510		13	A03	
		70	L7			
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	291		14		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		15		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		16		
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	17		

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

3180 µm

Version 1.2.20.35

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